# **NX5DV715**

# **Dual supply 1-of-2 VGA switch**

Rev. 3 — 4 November 2011

**Product data sheet** 

### 1. General description

The NX5DV715 is a dual supply 1-to-2 VGA switch. It integrates high-bandwidth SPDT switches with level-translating buffers and level translating switches to provide switching of input RGB, H-Sync, V-Sync and DDC signals to either of two output channels.

The NX5DV715 is characterized for operation from –40 °C to +85 °C.

#### 2. Features and benefits

- RGB switches:
  - ◆ Low ON resistance (4 Ω typical)
  - Low ON capacitance (12 pF typical)
  - Low output skew (50 ps)
- Low power consumption (< 2 μA)</p>
- Level translation of sync and DDC signals
- Over-voltage tolerant inputs
- ESD protection:
  - ◆ HBM JESD22-A114F Class 3A exceeds 4 kV
  - ♦ MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101D exceeds 1000 V
  - ◆ IEC61000-4-2 contact discharge exceeds 4 kV for I/Os
- Specified from -40 °C to +85 °C

# 3. Applications

- Notebook Computers
- Docking stations
- Digital projectors
- Computer monitors
- Servers
- Storage



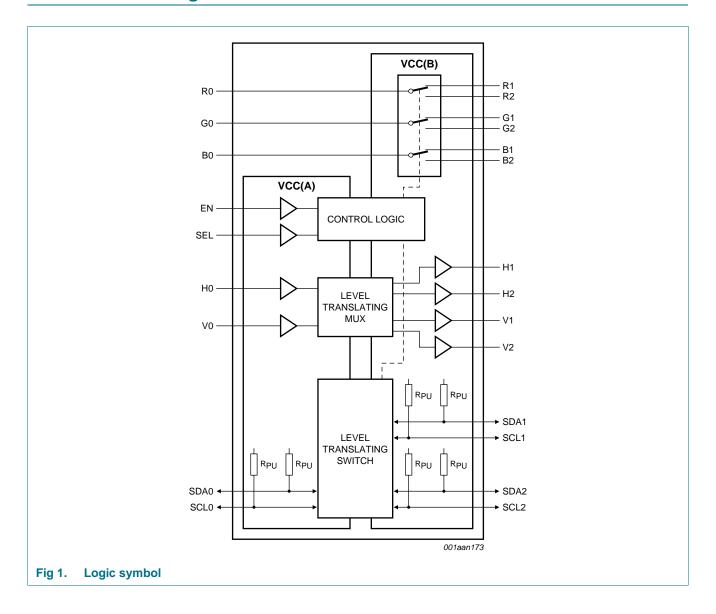
## Dual supply 1-of-2 VGA switch

# 4. Ordering information

Table 1. Ordering information

Type number	Package				
	Temperature range	Name	Description	Version	
NX5DV715HF	–40 °C to +85 °C	HWQFN32	plastic thermal enhanced very very thin quad flat package; no leads; 32 terminals; body $3\times6\times0.75~\text{mm}$	SOT1180-1	

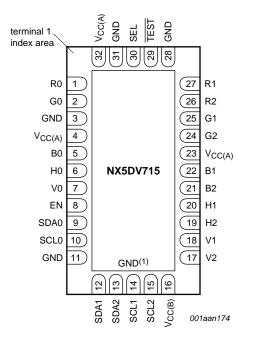
# 5. Functional diagram



#### **Dual supply 1-of-2 VGA switch**

# 6. Pinning information

#### 6.1 Pinning



Transparent top view

(1) This is not a supply pin, the substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad however if it is soldered the solder land should remain floating or be connected to GND.

#### Fig 2. Pin configuration SOT1180-1 (HWQFN32)

#### 6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
R0, G0, B0	1, 2, 5	RGB input or output
GND	3, 11, 28, 31	ground (0 V)
V <sub>CC(A)</sub>	4, 23, 32	supply voltage A
H0	6	horizontal sync input
V0	7	vertical sync input
EN	8	enable input (active HIGH)
SDA0	9	SDA0 input or output
SCL0	10	SCL0 input or output
SDA1, SDA2	12, 13	SDA input or output
SCL1, SCL2	14, 15	SCL input or output
V <sub>CC(B)</sub>	16	supply voltage B
V1, V2	18, 17	vertical sync output
H1, H2	20, 19	horizontal sync output

NX5DV715

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**Dual supply 1-of-2 VGA switch** 

Table 2. Pin description ... continued

Symbol	Pin	Description
R1, G1, B1, R2, G2, B2	27, 25, 22, 26, 24, 21	RGB input or output
TEST[1]	29	test pin (active LOW)
SEL	30	select input

<sup>[1]</sup> Test pin used to enable test mode. For normal usage, this pin must be connected to V<sub>CC(A)</sub>.

### 7. Functional description

The NX5DV715 integrates high-bandwidth SPDT switches, level-translating buffers and level translating SPDT switches to provide a complete solution for 1-to-2 switching of VGA signals. An enable input (EN) is used to enable or disable the device and a select input (SEL) is used to determine which output is selected. When EN = LOW the device is disabled; all switches will be off, pull-up resistors will be disabled and H1, V1, H2, V2 will be forced LOW.

#### 7.1 RGB switches

The NX5DV715 provides three identical single pole double throw high-bandwidth switches to route standard VGA RGB signals (see Table 3).

Table 3. Function table RGB

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

Input		Switch
EN	SEL	
Н	L	R0 to R1; G0 to G1; B0 to B1
Н	Н	R0 to R2; G0 to G2; B0 to B2
L	Χ	switches Rn, Gn, Bn off

#### 7.2 H-Sync/V-Sync level translator

The horizontal and vertical synchronization buffers have inputs (H0, V0) referenced to  $V_{CC(A)}$  and outputs (H1, V1 and H2, V2) that are referenced to  $V_{CC(B)}$ . This allows level translation of synchronization signals from as low as 2.0 V up to 5.5 V and supports low-voltage CMOS or TTL-compatible graphics controllers meeting the VESA specification for output drive of  $\pm 8$  mA. The EN input also controls the level shifter (See Table 4).

Table 4. Function table HV

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

Input		Switch
EN	SEL	
Н	L	H1 = H0; V1 = V0; H2, V2 = L
Н	Н	H2 = H0; V2 = V0; H1, V1 = L
L	Χ	L

**Dual supply 1-of-2 VGA switch** 

#### 7.3 Display-Data Channel Multiplexer

The NX5DV715 provides two identical SPDT active-level translating switches to route DDC signals (See <u>Table 5</u>). The switch outputs are limited to a diode drop less than the voltage applied on  $V_{CC(A)}$ . To provide VESA I<sup>2</sup>C-compatible signals 3.3 V should be applied to  $V_{CC(A)}$ . If voltage translation is not required  $V_{CC(A)}$  should be connected to  $V_{CC(B)}$ . Switch terminals include integrated pull-up resistors; inputs (SDA0, SCL0) are pulled up to  $V_{CC(A)}$ , outputs (SDA1, SCL1 and SDA2, SCL2) are pulled up to  $V_{CC(B)}$ . When the NX5DV715 is disabled (EN = LOW), the pull-up resistors are also disabled.

Table 5. Function table DDC

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

Input		Switch
EN	SEL	
Н	L	SDA0 to SDA1, SCL0 to SCL1
Н	Н	SDA0 to SDA2, SCL0 to SCL2
L	Χ	switches SDAn, SCLn off

### 8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC(A)}$	supply voltage A		-0.5	+6	V
$V_{CC(B)}$	supply voltage B		-0.5	+6	V
$V_{I}$	input voltage		[ <u>1]</u> -0.5	+6	V
$V_{SW}$	switch voltage		[ <u>1]</u> –0.5	+6	V
I <sub>IK</sub>	input clamping current	$V_1 < -0.5 \text{ V}$	-50	-	mA
I <sub>SK</sub>	switch clamping current	$V_1 < -0.5 \text{ V}$	-50	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
Io	output current	$V_O = 0 V \text{ to } V_{CC(B)}$	-	±50	mA
I <sub>CC</sub>	supply current	I <sub>CC(A)</sub> or I <sub>CC(B)</sub>	-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
I <sub>SW</sub>	switch current	$V_{SW} > -0.5 \text{ V or } V_{SW} < 6 \text{ V};$ source or sink current	-	±30	mA
		$V_{\rm SW}$ > -0.5 V or $V_{\rm SW}$ < 6 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±90	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +85  ^{\circ}\text{C}$	[2] _	250	mW

<sup>[1]</sup> The minimum input voltage rating may be exceeded if the input current rating is observed.

<sup>[2]</sup> For HWQFN32 package: above 137 °C the value of Ptot derates linearly with 20.5 mW/K.

#### **Dual supply 1-of-2 VGA switch**

# 9. Recommended operating conditions

Table 7. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC(A)}$	supply voltage A		2	3.3	5.5	V
$V_{CC(B)}$	supply voltage B		4.5	5.0	5.5	V
T <sub>amb</sub>	ambient temperature	operating in free-air	-40	+25	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$	<u>[1]</u> -	20	-	ns/V
		$V_{CC(A)} = 3 \text{ V to } 3.6 \text{ V}$	<u>[1]</u> -	10	-	ns/V
		$V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V}$	<u>[1]</u> -	5	-	ns/V

<sup>[1]</sup> Applies to control signal levels.

### 10. Static characteristics

Table 8. Static characteristics

 $V_{CC(B)} = 4.5 \text{ V}$  to 5.5 V;  $V_{CC(A)} = 2 \text{ V}$  to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	T <sub>amb</sub>	, = −40 °C to	+85 °C	Unit	
			Min	Typ[1]	Max		
General	'		'				
I <sub>CC(A)</sub>	supply current A	$V_{CC(A)} = 3.3 \text{ V}$ ; EN = $V_{CC(A)}$ or GND; for H1, H2, V1, V2: $I_O = 0 \text{ A}$ ; SCLn, SDAn unconnected	-	-	2.0	μΑ	
I <sub>CC(B)</sub>	supply current B	$V_{CC(B)}$ = 5.0 V; EN = $V_{CC(A)}$ or GND; for H1, H2, V1, V2: $I_O$ = 0 A; SCLn, SDAn unconnected	-	-	2.0	μА	
HV buffe	er						
$V_{IH}$	HIGH-level input voltage	V <sub>CC(A)</sub> = 3 V to 3.6 V	2	-	-	V	
$V_{IL}$	LOW-level input voltage	V <sub>CC(A)</sub> = 3 V to 3.6 V	-	-	8.0	V	
$V_{H}$	hysteresis voltage		-	50	-	mV	
I <sub>I</sub>	input leakage current	$V_{CC(B)} = V_{CC(A)} = 5.5 \text{ V};$ $V_I = \text{GND to } V_{CC(A)}$	-	-	±1	μΑ	
$V_{OH}$	HIGH-level output voltage	$I_O = -8 \text{ mA}$	V <sub>CC(B)</sub> 0.5	- <b>-</b>	-	V	
$V_{OL}$	LOW-level output voltage	$I_O = 8 \text{ mA}$	-	-	0.5	V	
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O}$ = 0 V to 5.5 V; $V_{CC(B)}$ = 0 V; $V_{CC(A)}$ = 0 V to 5.5 V	-	-	±1	μΑ	
RGB sw	itches						
I <sub>S(OFF)</sub>	OFF-state leakage current	$\begin{split} &V_{CC(B)} = 5.5 \text{ V; } V_{I} = 0.3 \text{ V or } 5.5 \text{ V;} \\ &V_{O} = 0 \text{ V to } V_{CC(B)}; \text{ EN } = V_{CC(A)} \text{ or GND;} \\ &\text{See } \underline{\text{Figure } 3} \end{split}$	-	-	±1	μА	
I <sub>S(ON)</sub>	ON-state leakage current	$V_{CC(B)} = 5.5 \text{ V}; V_I = 0.3 \text{ V or } 5.5 \text{ V};$ $V_O = 0 \text{ V to } V_{CC(B)}; \text{ EN } = V_{CC(A)};$ See Figure 4	-	-	±1	μА	
R <sub>ON</sub>	ON resistance	$V_I = 0.7 \text{ V}; I_{SW} = -10 \text{ mA}; \text{ See } \frac{\text{Figure 5}}{\text{and } \frac{\text{Figure 6}}{\text{ of } 100 \text{ m}}}$	[4] -	4	-	Ω	

#### **Dual supply 1-of-2 VGA switch**

Table 8. Static characteristics ...continued

 $V_{CC(B)} = 4.5 \text{ V}$  to 5.5 V;  $V_{CC(A)} = 2 \text{ V}$  to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		T <sub>amb</sub> = -	-40 °C to	0 °C to +85 °C	
				Min	Typ[1]	Max	
ΔR <sub>ON</sub>	ON resistance mismatch between channels	$V_I = GND$ to 0.7 V; $I_{SW} = -10$ mA	[2]	-	0.5	-	Ω
R <sub>ON(flat)</sub>	ON resistance (flatness)	$V_I = GND$ to 0.7 V; $I_{SW} = -10$ mA	[3]	-	0.5	-	Ω
C <sub>S(OFF)</sub>	OFF-state capacitance			-	4.5	-	рF
C <sub>S(ON)</sub>	ON-state capacitance			-	12	-	рF
SDAn, S	CLn						
I <sub>S(OFF)</sub>	OFF-state leakage current	$\begin{split} &V_{CC(B)} = 5.5 \text{ V; } V_{CC(A)} = 3.6 \text{ V; SCL0,} \\ &SDA0, SCL1, SCL2, SDA1, SDA2 = \\ &V_{CC(A)} \text{ or GND; } V_O = 0 \text{ V to } V_{CC(B)}; \\ &EN = GND; See \underline{Figure 3} \end{split}$	<u>[5]</u>	-	-	±1	μΔ
R <sub>ON</sub>	ON resistance	$V_{CC(A)} = 2 \text{ V}; V_I = 0.4 \text{ V}; I_{SW} = \pm 2 \text{ mA};$ See Figure 5 and Figure 7		-	9	-	Ω
C <sub>S(ON)</sub>	ON-state capacitance			-	15	-	рF
R <sub>PU</sub>	pull-up resistance			-	4.7	-	kΩ
Control I	Logic (SEL, EN)						
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$		1.7	-		V
		$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$		2.0	-		V
		$V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V}$		0.7V <sub>CC(A)</sub>	-		V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$		-	-	0.7	V
		$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$		-	-	0.8	V
		$V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V}$		-	-	0.3V <sub>CC(A)</sub>	V
V <sub>H</sub>	hysteresis voltage			-	50	-	m\
I <sub>I</sub>	input leakage current	$V_{CC(A)} = 5.5 \text{ V}; V_I = \text{GND to } V_{CC(A)}$		-	-	±1	μΑ

<sup>[1]</sup> All typical values are measured at  $V_{CC(B)} = 5 \text{ V}$ ,  $V_{CC(A)} = 3.3 \text{ V}$  and  $T_{amb} = 25 \text{ °C}$  unless otherwise specified.

<sup>[2]</sup> Measured at identical V<sub>CC</sub>, temperature and input voltage.

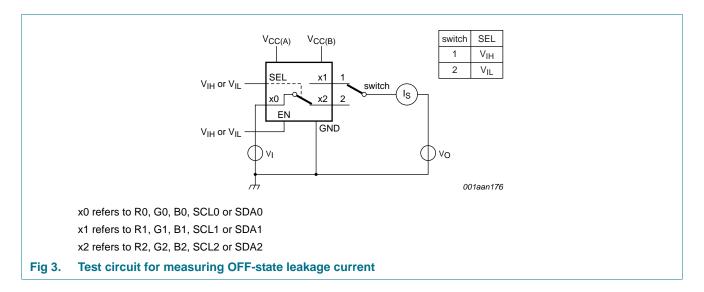
<sup>[3]</sup> Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and temperature.

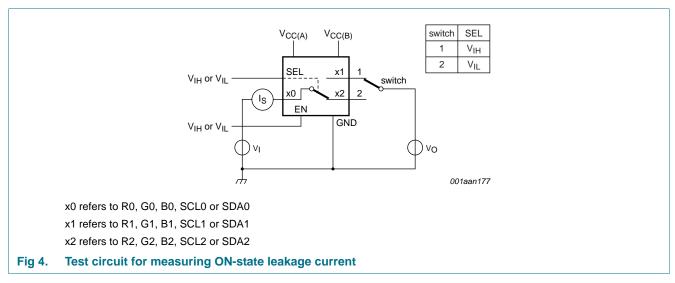
<sup>[4]</sup> Guarantees the LOW level.

<sup>[5]</sup> Guarantees the HIGH level.

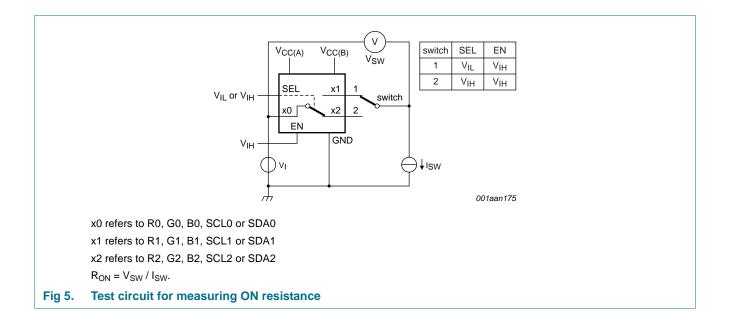
**Dual supply 1-of-2 VGA switch** 

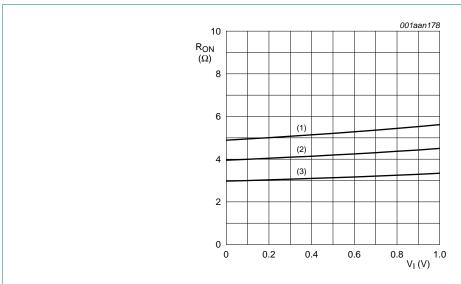
#### 10.1 Test circuits and waveforms





#### **Dual supply 1-of-2 VGA switch**

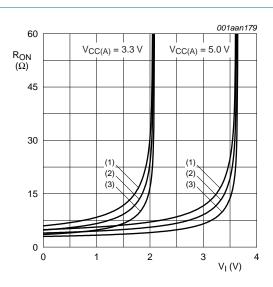




- (1)  $T_{amb} = 85 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = -40 \, ^{\circ}C$

Fig 6. ON resistance as a function of input voltage (RGB switches)

#### **Dual supply 1-of-2 VGA switch**



- (1)  $T_{amb} = 85 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = -40 \, ^{\circ}C$

Fig 7. ON resistance as a function of input voltage (DDC switches)

# 11. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; Voltages are referenced to GND (ground = 0 V;  $V_{CC(B)}$  = 4.5 V to 5.5 V;  $V_{CC(A)}$  = 2 V to 5.5 V.

Symbol	Parameter	Conditions		T <sub>amb</sub> =	-40 °C to ⋅	+85 °C	Unit
					Typ[1]	Max	
t <sub>pd</sub>	propagation delay	H0 to H1, H2 and V0 to V1, V2; See Figure 8 and Figure 9	[2]	-	3	-	ns
t <sub>en</sub>	enable time	EN and SEL to all other outputs; See Figure 10 and Figure 11		-	15	-	ns
t <sub>dis</sub>	disable time	EN and SEL to all other outputs; See Figure 10 and Figure 11		-	5	-	ns
t <sub>b-m</sub>	break-before-make time	See Figure 12		-	10	-	ns
t <sub>sk(o)</sub>	output skew time	Skew between any Rn, Gn and Bn ports; see <u>Figure 8</u>	[3]	-	50	-	ps

- [1] All typical values are measured at  $V_{CC(B)}$  = 5 V;  $V_{CC(A)}$  = 3.3 V;  $T_{amb}$  = 25 °C.
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [3] Guaranteed by design.

### **Dual supply 1-of-2 VGA switch**

#### 11.1 Test circuits and waveforms

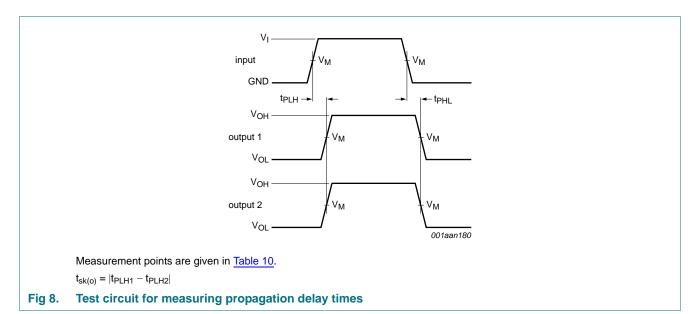
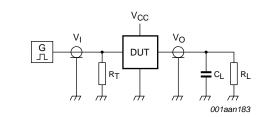


Table 10. Measurement points

Input		Output		
$V_{M}$	VI	V <sub>X</sub>	V <sub>M</sub>	
0.5V <sub>CC(A)</sub>	GND to V <sub>CC(A)</sub>	0.9V <sub>OH</sub>	0.5V <sub>CC(B)</sub>	



Test data is given in Table 11.

Definitions:

DUT = Device Under Test.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

C<sub>L</sub> = Load capacitance including test jig and probe.

 $R_L$  = Load resistance.

#### Fig 9. Test circuit for measuring propagation delay times

Table 11. Test data

Input	Load		
$t_r$ , $t_f$	C <sub>L</sub>	R <sub>L</sub>	
≤ 2.5 ns	10 pF	1 kΩ	

#### **Dual supply 1-of-2 VGA switch**

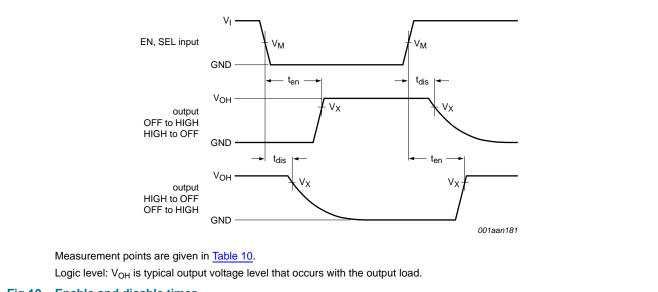
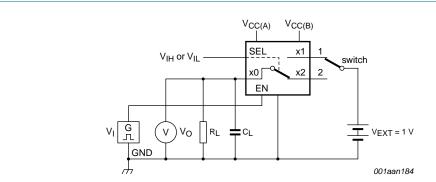
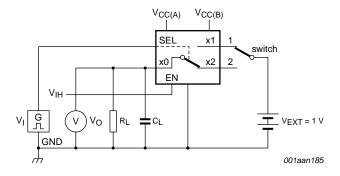


Fig 10. Enable and disable times



a. EN to switch outputs



b. SEL to switch outputs

Test data is given in <u>Table 12</u>. x0 refers to R0, G0, B0, SCL0 or SDA0 x1 refers to R1, G1, B1, SCL1 or SDA1 x2 refers to R2, G2, B2, SCL2 or SDA2

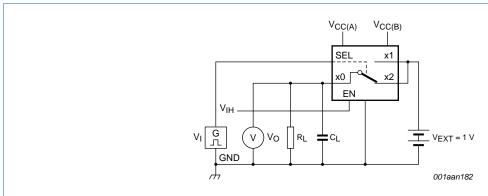
Fig 11. Test circuit for measuring enable and disable times

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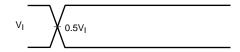
#### **Dual supply 1-of-2 VGA switch**

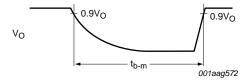
Table 12. Test data

Input		Load		
$t_r, t_f$	VI	C <sub>L</sub>	R <sub>L</sub>	
≤ 2.5 ns	GND to V <sub>CC(A)</sub>	10 pF	100 Ω	



a. Test circuit





b. Input and output measurement points

Test data is given in <u>Table</u> 12. x0 refers to R0, G0, B0, SCL0 or SDA0 x1 refers to R1, G1, B1, SCL1 or SDA1 x2 refers to R2, G2, B2, SCL2 or SDA2

Fig 12. Test circuit for measuring break-before-make timing

#### **Dual supply 1-of-2 VGA switch**

# 12. Additional dynamic characteristics

Table 13. Additional dynamic characteristics

V<sub>CC(B)</sub> = 5.0 V ± 10 %, V<sub>CC(A)</sub> = 2 V to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		$T_{amb}$ = -40 °C to +85 °C			Unit
				Min	Тур	Max	
f <sub>(-3dB)</sub>	-3 dB frequency response	$R_L = 50 \Omega$ ; see Figure 13	1]	-	600	-	MHz
$\alpha_{ins}$	Insertion loss	$f_i$ = 1 MHz; $R_L$ = $R_S$ = 50 $\Omega$ ; see <u>Figure 13</u>		-	0.6	-	dB
Xtalk	crosstalk	between switches; $f_i = 50 \text{ MHz}$ ; $R_L = 50 \Omega$ ; see Figure 13	<u>1]</u>	-	-50	-	dB

[1]  $f_i$  is biased at  $0.5V_{CC}$ .

#### 12.1 Test circuits

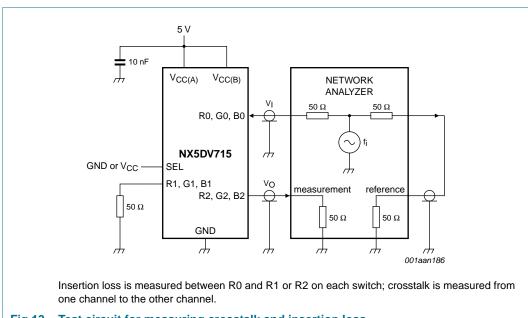


Fig 13. Test circuit for measuring crosstalk and insertion loss

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**Dual supply 1-of-2 VGA switch** 

# 13. Application information

The NX5DV715 provides the level shifting necessary to drive two standard VGA ports from a graphic controller as low as 2.2 V. Internal buffers drive the H-Sync and V-Sync signals to VGA standard TTL levels. The DDC multiplexer provides level shifting by clamping signals to a diode drop less than  $V_{CC(A)}$  (See Figure 14). Connect  $V_{CC(A)}$  to 3.3 V for normal operation, or to  $V_{\text{CC}(B)}$  to disable voltage clamping for DDC signals

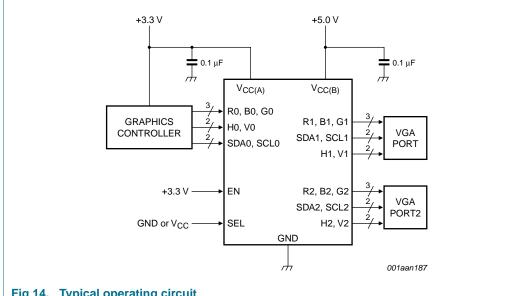


Fig 14. Typical operating circuit

#### **Dual supply 1-of-2 VGA switch**

## 14. Package outline

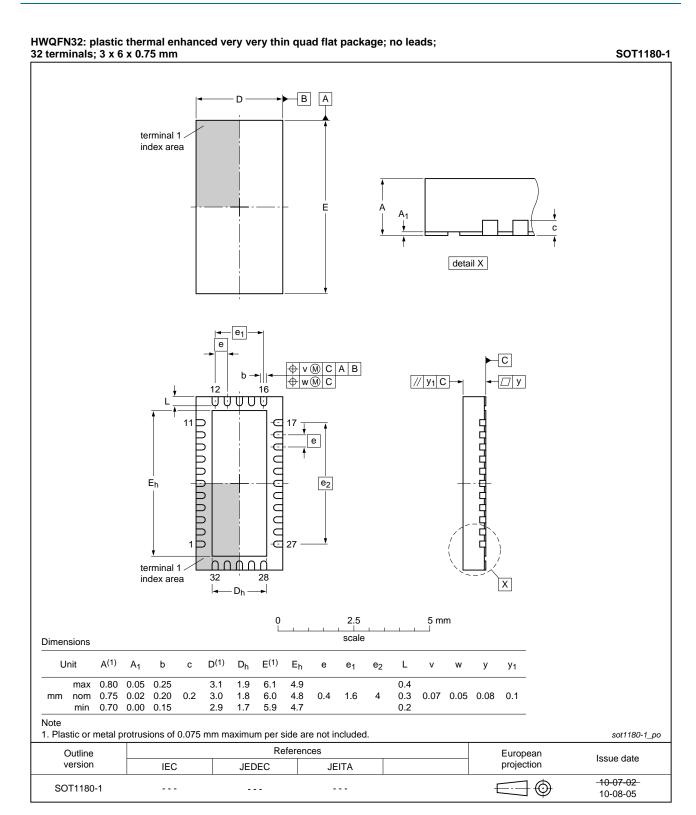


Fig 15. Package outline SOT1180-1 (HWQFN32)

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### Dual supply 1-of-2 VGA switch

### 15. Abbreviations

#### Table 14. Abbreviations

Acronym	Description
CDM	Charged Device Model
DDC	Display Data Channel
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
RGB	Red Green Blue
TTL	Transistor-Transistor Logic
VESA	Video Electronics Standards Association

# 16. Revision history

#### Table 15. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX5DV715 v.3	20111104	Product data sheet	-	NX5DV715 v.2
Modifications:	<ul> <li>Legal pages</li> </ul>	updated		
NX5DV715 v.2	20110725	Product data sheet	-	NX5DV715 v.1
NX5DV715 v.1	20101220	Product data sheet	-	-

#### Dual supply 1-of-2 VGA switch

### 17. Legal information

#### 17.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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NX5DV715

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#### **Dual supply 1-of-2 VGA switch**

### 19. Contents

1	General description 1
2	Features and benefits 1
3	Applications
4	Ordering information
5	Functional diagram 2
6	Pinning information 3
6.1	Pinning
6.2	Pin description
7	Functional description 4
7.1	RGB switches 4
7.2	H-Sync/V-Sync level translator 4
7.3	Display-Data Channel Multiplexer 5
8	Limiting values 5
9	Recommended operating conditions 6
10	Static characteristics 6
10.1	Test circuits and waveforms 8
11	Dynamic characteristics 10
11.1	Test circuits and waveforms
12	Additional dynamic characteristics 14
12.1	Test circuits
13	Application information
14	Package outline
15	Abbreviations
16	Revision history
17	Legal information
17.1	Data sheet status
17.2	Definitions
17.3	Disclaimers
17.4	Trademarks19
18	Contact information
10	Contents 20

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